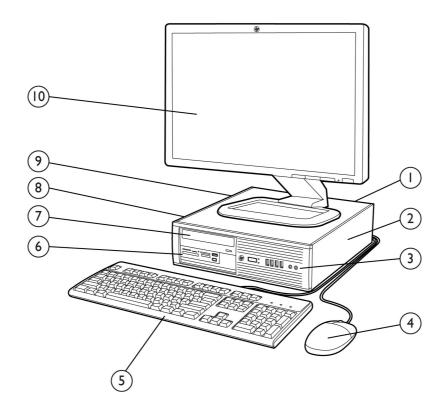
Overview

HP Compaq 6200 Pro Small Form Factor Business PC

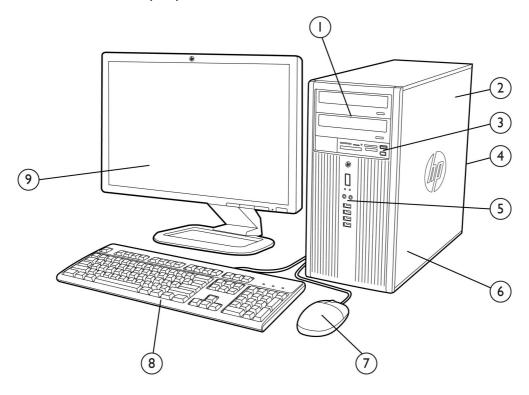


- Rear I/O includes (6) USB 2.0 ports, serial port, PS/2 mouse and keyboard ports, RJ-45 network interface, DisplayPort v1.1a and VGA video interfaces, and 3.5mm audio in/out jacks
- 2 Low profile expansion slots include (1) PCI, (2) PCI Express x1 and (1) PCI Express x16 graphics
- 3 Front I/O includes (4) USB 2.0 ports, dedicated headphone output, and a microphone/headphone jack
- 4 HP Mouse
- 5 HP Keyboard
- 6 3.5" external drive bay supporting a media card reader or a secondary hard disk drive
- 7 5.25" external drive bay supporting an optical disk drive
- 8 3.5" internal drive bay supporting primary hard disk drive
- 9 240W standard or 90% high efficiency Power Supply
- 10 HP Monitor (sold separately)



Overview

HP Compaq 6200 Pro Microtower Business PC



- 1 (2) 5.25" external drive bays supporting optical disk drives or removable hard disk drives; (2) 3.5" internal drive bays supporting hard disk drives
- 2 320W standard or 90% high efficiency Power Supply
- 3 3.5" external drive bay supporting the HP Media Card Reader
- Rear I/O includes (6) USB 2.0 ports, serial port, PS/2 mouse and keyboard ports, RJ-45 network interface, DisplayPort v1.1a and VGA video interfaces, and 3.5mm audio in/out jacks
- 5 Front I/O includes (4) USB 2.0 ports, dedicated headphone output, and a microphone/headphone jack
- 6 Full height expansion slots include (1) PCI, (2) PCI Express x1 and (1) PCI Express x16 graphics
- 7 HP Mouse
- 8 HP Keyboard
- 9 HP Monitor (sold separately)

Overview

At A Glance

- Choice of two professional chassis form factors: SFF & MT
- PC chassis and all internal components and modules are 100% free of brominated flame retardants (BFRs) and Polyvinyl Chloride (PVC).
- UEFI BIOS developed and engineered by HP for better security, manageability and software image stability
- Intel Q65 Express chipset supporting Intel 2nd generation Core processors and featuring Intel HD Graphics)
- Intel 82579LM GbE integrated network connection
- DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Integrated dual independent monitor support via VGA and digital DisplayPort v1.1a video interfaces
- Standard efficiency or 90% high efficiency energy saving power supplies available ENERGY STAR qualified
- Guaranteed lengthy purchase lifecycles and image stability
- Software image fully compatible across all models and form factors
- Created using industry leading Design for Environment standards
- Selected configurations with global availability easily set up and ordered through HP.com Business to Business portals (http://h10019.www1.hp.com/business-site/index.html)
- Tailored HP Factory Express deployment and lifecycle services available (http://h71028.www7.hp.com/enterprise/cache/97688-0-0-225-121.aspx)
- Protected by HP Services, including standard warranties up to 5-5-5 (terms and conditions vary by country; certain restrictions and exclusions apply)
- Tool-less serviceability features for easier upgrades and repairs



Standard Features and Configurable Components (availability may vary by country)

Operating Systems

Preinstalled Genuine Windows Vista Home Basic ¹

Genuine Windows Vista Business 1

Free Linux 2.0

Genuine Windows 7 Professional Edition (32-bit or 64-bit) Genuine Windows 7 Ultimate Edition (32-bit or 64-bit)

FreeLnx

Genuine Windows 7 Professional Edition (32-bit or 64-bit)² Genuine Windows 7 Ultimate Edition (32-bit or 64-bit)

Free Linux 2.0

Supported Genuine Windows XP Professional Edition

Genuine Windows 7 Home Basic Edition (32-bit)

Genuine Windows 7 Home Premium Edition (32-bit or 64-bit)

Genuine Windows Vista Enterprise Edition¹ Genuine Windows 7 Enterprise Edition

Certified Novell SUSE Linux Enterprise Desktop 11†

Red Hat Enterprise Linux 64^{††}

¹ Certain Windows Vista product features require advanced or additional hardware. Refer to the following web sites for details: www.microsoft.com/windowsvista/getready/hardwarereqs.mspx www.microsoft.com/windowsvista/getready/capable.mspx

Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: www.windowsvista.com/upgradeadvisor

† The following features are not supported by Novell SUSE Linux Enterprise Desktop:

- Intel Gigabit CT Desktop NIC
- Broadcom NetXtreme Gigabit Ethernet Plus
- HP 22-in-1 Media Card Reader
- HP ProtectTools
- HP Blu-ray Writer playback of commercial movies
- DisplayPort video interface
- HP 2nd serial port adapter
- Power Management features
- Systems configured with Linux do not qualify for ENERGY STAR

†† The following features are not supported by Red Hat Enterprise Linux 64:

- TPM v1.2 embedded Security Chip
- Intel Gigabit CT Desktop NIC
- HP Wireless 802.11b/g/n NIC
- HP 22-in-1 Media Card Reader
- HP Blu-ray Writer
- HP FireWire / IEEE 1394 PCI Card



Standard Features and Configurable Components (availability may vary by country)

- HP 2nd serial port Adapter
- HP USB Smart Card (CCID) Keyboard
- AMD Radeon HD 6350 Graphics
- NVIDIA Quadro NVS 295 Graphics
- Power Management features
- Systems configured with Linux do not qualify for ENERGY STAR

Value Added Software (included with all models; not included when configured with FreeDOS)

HP Vision Diagnostics

PDF Complete Special Edition

Microsoft Office Starter Edition 2010

Value Added Software (included with select models; not included when configured with FreeDOS)

HP Power Assistant v2.0 HP Virtual Rooms
Computer Setup Utility Corel WinDVD

Roxio Creator Business Mozilla Firefox for Solutions 2011

Norton Internet Security 2011 ¹ HP Direct Connect

HP MyRoom Box Online Storage - 10GB (United States of America only)

HP Business PC Services and Feature

HP Stable Platform Program
Intel Stable Platform Program

Business-to-Business Portals

Factory Express Deployment and Lifecycle Services

Trusted Platform Module (TPM v1.2 *)

HP Global Series Services

Service and Support

On-site warranty and service¹: This limited warranty and service offering delivers parts, labor and on-site repair for terms up to 5 years. Response time is next business day² and includes free telephone support³ 24 x 7. Global coverage² ensures any product purchased in one country and transferred to another non-restricted country will remain fully covered under the original warranty and service offering. Some countries/regions do not offer one year onsite and labor.

- ¹ Terms and conditions may vary by country. Certain restrictions and exclusions apply
- ² On-site services may be provided pursuant to a service contract between HP and an authorized HP third party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country
- ³ Technical telephone support applies only to HP configured, HP and HP qualified third party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.

Chipset

Intel Q65 Express



¹ Includes a 60 day subscription for virus definition and minor program revision updates. Internet access required to receive updates.

^{*} TPM module disabled where restricted by law, i.e. Russia.

Standard Features and Configurable Components (availability may vary by country)

Processor

Intel® Celeron® Processors

Intel Celeron G440 Processor

1.60 GHz, 1M cache, 1 core/1 thread Intel HD Graphics

Intel Celeron G460 Processor

1.80 GHz, 1M cache, 1 core/2 threads Intel HD Graphics

Intel® Pentium® Processors

Intel Pentium G620 Processor

2.60 GHz, 3M cache, 2 cores/2 threads Intel HD Graphics

Intel Pentium G630 Processor

2.70 GHz, 3M cache, 2 cores/2 threads Intel HD Graphics

Intel Pentium G840 Processor

2.80 GHz, 3M cache, 2 cores/2 threads Intel HD Graphics

Intel Pentium G850 Processor

2.90 GHz, 3M cache, 2 cores/2 threads Intel HD Graphics

Intel Pentium G860 Processor

3.00 GHz, 3M cache, 2 cores/2 threads Intel HD Graphics

Intel® 2nd Generation Core™ i3 Processors

Intel Core i3-2100 Processor

3.10 GHz, 3M cache, 2 cores/4 threads Intel HD Graphics 2000

Intel Core i3-2105 Processor

3.10 GHz, 3M cache, 2 cores/4 threads Intel HD Graphics 3000

Intel Core i3-2120 Processor

3.30 GHz, 3M cache, 2 cores/4 threads Intel HD Graphics 2000

Intel Core i3-2130 Processor

3.40 GHz, 3M cache, 2 cores/4 threads Intel HD Graphics 2000

Intel® 2nd Generation Core™ i5 Processors

Intel Core i5-2400 Processor

3.10 GHz, 6M cache, 4 cores/4 threads Intel HD Graphics 2000 Intel Stable Image Platform Program (SIPP)

Intel Core i5-2500 Processor

3.30 GHz, 6M cache, 4 cores/4 threads Intel HD Graphics 2000 Intel Stable Image Platform Program (SIPP)

Intel® 2nd Generation Core™ i7 Processors

Standard Features and Configurable Components (availability may vary by country)

Intel Core i7-2600 Processor

3.40 GHz, 8M cache, 4 cores/8 threads

Intel HD Graphics 2000

Intel Stable Image Platform Program (SIPP)

System Memory Support

The HP Compaq 6200 Elite Series supports the 2nd generation Intel® Core™ processor family. Based on a new PC micro-architecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the processor includes an integrated memory controller (IMC). The IMC supports DDR3 protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC unbuffered DDR3 memory with a maximum of two UDIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- DDR3 memory data transfer rates of 1066 MT/s (PC3-8500) and 1333 MT/s (PC3-10600)
- 64-bit wide channels
- DDR3 I/O voltage of 1.5V
- Maximum memory bandwidth of 10.6 GB/s in single-channel mode or 21 GB/s in dual-channel mode assuming DDR3 1333 MT/s (PC3-10600)
- The largest memory capacity possible is 32GB using four (4) 8GB DIMMs

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

Memory Configurations:

Slot 1 is black and must always be populated. Not all memory configurations possible are represented below.

NOTE:

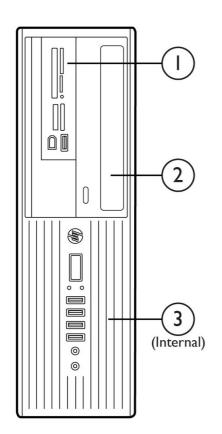
For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Total Memory	Slot			
	Channel A		Channel B	
	1 (black)	2 (white)	3 (white)	4 (white)
2 GB	2 GB	unpopulated	unpopulated	unpopulated
4 GB	2 GB	unpopulated	2 GB	unpopulated
(dual channel)				
8 GB	2 GB	2 GB	2 GB	2 GB
(dual channel)				
16 GB	4 GB	4 GB	4 GB	4 GB
(dual channel)				

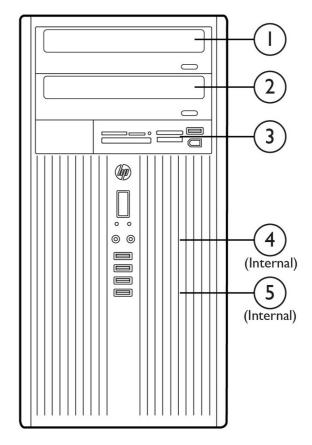


Standard Features and Configurable Components (availability may vary by country)

Small Form Factor



Microtower



Storage Drive Support						
SFF MT						
	MCR	ODD	HDD	MCR	ODD	HDD
Quantity Supported	1	1	2	1	2	2
Position	1	2	1,3	3	1,2	4,5

Data Storage Drives

160-GB Hard Disk Drives

HP 160GB 10K rpm SATA 3.0Gb/s 2.5" Hard Disk Drive Includes 3.5" adapter

250-GB Hard Disk Drives

HP 250-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

300-GB Hard Disk Drives

HP 300GB 10K rpm SATA 3.0Gb/s 2.5" Hard Disk Drive Includes 3.5" adapter



Standard Features and Configurable Components (availability may vary by country)

320-GB Hard Disk Drives

HP 320-GB 7.2K rpm SATA 3.0Gb/s 2.5" Self-Encrypting Drive

Includes 3.5" adapter

500-GB Hard Disk Drives

HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

750-GB Hard Disk Drives

HP 750-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

1-TB Hard Disk Drives

HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Solid State Drives

HP 80-GB SATA 3.0Gb/s Solid State Drive

Includes 3.5" adapter

HP 120-GB SATA 3.0Gb/s Solid State Drive

Includes 3.5" adapter when installed in SFF, MT

HP 128-GB SATA 3.0Gb/s Solid State Drive

Includes 3.5" adapter when installed in SFF, MT

HP 160-GB SATA 3.0Gb/s Solid State Drive

Includes 3.5" adapter

HP 256-GB SATA 3.0Gb/s Solid State Drive

Includes 3.5" adapter when installed in SFF, MT

Optical Disc Drives

HP DVD-ROM Drive

HP SuperMulti DVD Writer Drive^{1,2,3}

HP Blu-ray Writer Drive

- ¹ For playing DVDs, Corel WinDVD 8
- ² For writing CDs, choice of Sonic/Roxio Easy Media Creator 9 orRoxio Business Creator 10
- ³ For writing CDs and DVDs, video editing and authoring DVDs, choice of Sonic/Roxio Easy Media Creator 9 or Roxio Business Creator 10

Media Card Readers

HP 22-n-1 Media Card Reader



Standard Features and Configurable Components (availability may vary by country)

Security Solutions and Capabilities

Trusted Platform Module (TPM) 1.2¹

Stringent security (via BIOS)²

SATA port disablement (via BIOS)

Drive lock

Serial, parallel, USB enable/disable (via BIOS)

Optional USB Port Disable at factory (user configurable via BIOS)

Removable media write/boot control

Power-On password (via BIOS)

Setup password (via BIOS)

HP Solenoid Hood Lock / Sensor

Support for chassis padlocks and cable lock devices

Intel Identify Protection Technology (IPT):

Models configured with Intel 2nd generation Core processors have the ability to utilize advanced security protection for online transactions. IPT, used in conjunction with participating web sites, provides double identity authentication by adding a hardware component in addition to the usual user name and password. IPT is initialized through an HP ProtectTools module (sold separately).

- ¹ TPM module disabled where use is restricted by law; for example, Russia.
- ² This setting is defaulted to disable, but when enabled, the PW jumper will not clear the BIOS pre-boot authentication passwords.

Network Interface Connections

Intel 82579LM integrated GbE Network Connection Intel Gigabit CT Desktop NIC (PCle x1)
HP 802.11 b/g/n Wireless NIC (PCle x1)

Graphics

Intel HD Graphics 2000/3000 (integrated)

AMD FirePro 2270 Graphics (PCle x16)

AMD Radeon HD 6350 Graphics (PCle x16)

AMD Radeon HD 6450 Graphics (PCle x16)

AMD Radeon HD 6570 Graphics (PCle x16)

Available on the Microtower only

Nvidia NVS 295 Graphics (PCle x16)

Nvidia NVS 300 Graphics (PCle x16)

Nvidia NVS 300 Graphics (PCle x1)

NVIDIA GeForce 405 Graphics (PCle x16)

Available in China only

HP DisplayPort Cable



Standard Features and Configurable Components (availability may vary by country)

HP DisplayPort to DVI-D Adapter

HP DisplayPort to HDMI Adapter

HP DisplayPort to VGA Adapter

Surround View (enable/disable via F10)*

* For Windows 7 systems, this enables the Surround View option that allows the integrated graphics controller and an AMD PCI Express graphics card to work at the same time for multi-monitor support.

Multi-Media

High Definition Audio with Realtek ALC261 codec (all ports are stereo)

Microphone/Headphone* and dedicated headphone front ports (3.5mm)

Line-out and Line-In rear Ports* (3.5mm)

Multi-streaming capable*

Internal Speaker (standard)

HP Thin USB Powered Speakers

HP USB HD 720P Business Webcam

HP Business Headset

SRS Premium Sound

* The front microphone port is re-taskable as a Line-in, Microphone-in or Headphone-in port. Rear audio input ports are re-taskable as a Line-in or Microphone-in port. External speakers must be powered externally. Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks. This allows for different audio applications to use separate audio ports on the system. For example, the front jacks could be used with a headset for a communications application while the rear jacks are being used with external speakers and a multimedia application.

Input/Output Devices

HP PS/2 Standard Keyboard

HP USB Standard Keyboard

HP USB Keyboard with USB ports

HP USB Smart Card (CCID) Keyboard

HP USB Mini Keyboard

HP USB and PS/2 Washable Keyboard

HP PS/2 Optical Mouse

HP USB Optical Mouse

HP USB Laser Mouse

HP USB and PS/2 Washable Mouse



Standard Features and Configurable Components (availability may vary by country)

Miscellaneous Devices and Configurations

HP FireWire IEEE 1394 PCle x1 Card

HP SuperSpeed USB 3.0 PCle x1 Card

HP Serial Port Adapter (RS-232 compatible); provides 2nd Serial Port

HP Parallel Port Adapter

HP eSATA Port Adapter

HP SFF Tower Stand



After-Market Options (availability may vary by region)

Communication Devices	Part Number
Intel Gigabit CT Desktop NIC (PCle x1)	FH969AA
Broadcom NetXtreme GbE Ethernet Plus NIC (PCle x1)	FS215AA
HP Wireless 802.11 b/g/n NIC (PCle x1)	FH971AA
Graphics Solutions	Part Number
AMD FirePro 2270 Graphics (PCle x16)	QK551AA
AMD Radeon HD 6350 Graphics (PCle x16)	QK638AA
AMD Radeon HD 6450 Graphics (PCle x16)	QM229AA
AMD Radeon HD 6570 Graphics (PCle x16) (Available in Microtower only)	QP027AA
Nvidia Quadro NVS 295 Graphics (PCIe x16)	FY943AA
Nvidia Quadro NVS 300 Graphics (PCle x16)	BV456AA
Nvidia NVS 300 Graphics (PCle x1)	BV457AA
Nvidia GeForce 405 Graphics (PCIe x16)	QM194AA
(Available in China only)	
HP DisplayPort Cable Kit	VN567AA
HP DisplayPort To Dual Link DVI-D Adapter	NR078AA
HP DisplayPort To DVI-D Adapter	FH973AA
HP DisplayPort to HDMI Adapter	BP937AA
HP DisplayPort to VGA Adapter	AS615AA
HP DMS-59 to Dual DVI Cable	DL139A
HP DMS-59 to Dual DisplayPort Adapter	XP688AA
Data Storage Drives and Accessories	Part Number
HP 160GB 10K rpm SATA 3.0Gb/s 2.5" Hard Disk Drive Includes 3.5" adapter	FX618AA
HP 300GB 10K rpm SATA 3.0Gb/s 2.5" Hard Disk Drive Includes 3.5" adapter	FX619AA
HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive	QK554AA
HP 750-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive	QR469AA
HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive	QK555AA
HP 80-GB SATA 3.0Gb/s Solid State Drive	BM848AA
HP 128-GB SATA 3.0Gb/s Solid State Drive	TBD
HP 160-GB SATA 3.0Gb/s Solid State Drive	BW321AA
HP 256-GB SATA 3.0Gb/s Solid State Drive	TBD



After-Market Options (availability may vary by region)	
HP eSATA Adapter	FH966AA
HP Removable SATA Hard Drive Enclosure (frame & carrier)	RY102AA
HP Removable SATA Hard Drive Enclosure (carrier only)	RY103AA
Input Devices	Part Number
HP PS/2 Standard Keyboard	DT527A
HP USB Standard Keyboard	DT528A
HP USB Keyboard with USB ports	BT330AA
HP USB Mini Keyboard	AS601AA
HP USB Gray Keyboard	DT529A
HP USB Smart Card (CCID) Keyboard	BV813AA
HP USB Keyboard and Mouse Kit	RC465AA
HP USB Washable Keyboard	VF097AA
HP USB and PS/2 Washable Mouse	BM866AA
HP USB and PS/2 Washable Keyboard and Mouse Kit	BU207AA
HP PS/2 Optical Mouse	EY703AA
HP USB Optical Mouse	DC172AT
HP USB Laser Mouse	GW405AT
HP USB Travel Mouse	RH304AA
HP 2.4GHz Wireless Keyboard and Mouse	NB896AA
System Memory	Part Number
HP 1 GB DIMM	AT023AA
HP 2 GB DIMM	AT024AA
HP 4 GB DIMM	VH638AA
Multi-Media Devices	Part Number
HP Thin USB Powered Speakers	KK912AA
HP DVD-ROM Drive	AR629AA
HP SuperMulti DVD Writer Drive	AR630AA
HP Blu-ray Writer Drive	AR482AA
HP USB HD 720P Business Webcam	QP896AA
HP Business Headset	QK550AA



After-Market Options (availability may vary by region)

Removable Media Storage	Part Number
HP USB External Diskette Drive	DC141B
HP 22-n-1 Media Card Reader	AR941AA

Security Devices	Part Number
HP/Kensington MicroSaver Cable Lock	PC766A
HP Business PC Security Lock	PV606AA
HP SFF Solenoid Lock and Hood Sensor	BP428AA
HP MT Solenoid Lock and Hood Sensor	DE618A
HP SFF Wall Mount/Security Sleeve	VN570AA
HP Keyed Lock Cable	BV411AA

HP Client Automation Software	Part Number
HP Client Automation - Standard Edition (single seat)	T3488AA
HP Client Automation - Standard Edition (10 seats)	TA599AA
HP Client Automation - Standard Edition (100 seats)	TA600AA
HP Client Automation - Standard Edition (500 seats)	TA601AA
HP Client Automation - Standard Edition (1,000 seats)	T3489AA

Stands and Accessories	Part Number
HP Integrated Work Center Stand (SFF)	QK549AA
HP SFF Tower Stand	VN569AA
HP Serial Port Adapter (RS-232 compatible)	PA716A
HP Parallel Port Adapter	KD061AA
HP 5.25" Blank Bezel Kit (50 pack)	DC177B
HP FireWire IEEE 1394 Card	PA997A
HP SuperSpeed USB 3.0 Card	BM867AA

N/A

QuickSpecs

Technical Specifications

Weights & Dimensions		
(configured with 1 HDD and 1	SFF	MT

ODD)

Chassis 4.0 x 13.3 x 14.9 in (100 x 338 x 379 mm) 14.9 x 7.0 x 17.0 in (377 x 177 x 431 mm)

 $(H \times W \times D)$

System Volume 782.77 cu in (12.8 L) 1739 cu in (28.5 L)

Tower Stand 1.1 x 7.0 x 7.9 in (29 x 178 x 200 mm)

 $(H \times W \times D)$

Packaging 9.0 x 19.7 x 23.4 in (229 x 500 x 594 mm) 19.7 x 12.2 x 23.6 in (500 x 310 x 600 mm)

 $(H \times W \times D)$

 System Weight*
 16.7 lb (7.6 kg)
 20.5 lb (9.3 kg)

 Shipping Weight*
 17.9 lb (8.1 kg)
 28.8 lb (13.1 kg)

Max Supported Weight 77.0 lb (35.0 kg) 20.0 ib (13.1 kg) N/A

(desktop orientation)

I/O Ports

USB 2.0 Front - four (4) ports

Rear - six (6) ports

Serial one RS-232 compatible port standard

second port available optionally

Parallel one port available as an option eSATA one port available as an option

PS/2 color coded support for keyboard (purple) and mouse (green)

Video VGA and DisplayPort v1.1a provide integrated dual independent monitor support

DVI output available via optional DisplayPort to DVI Adapter

Audio Front - microphone & headphone

Rear - line input (supports microphone or line input), line out

All ports are 3.5mm in diameter

NOTE:

See Audio/Visual section for information on re-taskable audio ports.

NIC Industry standard RJ-45 port accesses the integrated network interface controller



Technical Specifications

Slots	SFF	MT
Conventional PCI Revision 2.3 5 volt	1 each 2.5" low profile 6.6" length 25W max. power	l each 4.2" full height 6.6" length 25W max. power
DCI F	2 each x1 slots 2.5" low profile 6.6" length 10W max. power	2 each x1 slots 4.2" full height 6.6" length 10W max. power
PCI Express 2.0	1 each x16 slot 2.5" low profile 6.6" length 25W max. power	1 each x16 slot 4.2" full height 6.6" length 75W max. power

Bays	SFF	MT

3.5" external	I bay available for Media Card Reader unless used for a secondary hard o		
5.25" external	1 each	2 each	
	8.19" depth	8.19" depth	
Internal HDD Bays	1 each	2 each	
	3.5" drives	3.5" drives	

Controller

Hard Drive Controller These systems provide four serial ATA (SATA) interfaces that support transfer rates up to 6.0 Gb/s

(for ports 0 and 1, 3 Gb/s on all others). These systems can also support an external SATA (eSATA)

device through an optional bracket/cable assembly.

SATA Interfaces 2 ea. SATA 3.0

1 ea. SATA 2.0 1 ea. eSATA

Host SATA Controller Advanced Host Controller Interface (AHCI) Revision 1.2. The specification includes a description of

the hardware/software interface between system software and the host controller hardware.



Technical Specifications

Unit Environment and Operating Conditions

General Unit Operating Guidelines

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's recirculated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Operating: 50° to 95° F (10° to 35° C)* Temperature Range

Non-operating: -22° to 140° F(-30° to 60° C)

Operating: 10% to 90% (non-condensing at ambient) Relative Humidity

Non-operating: 5% to 95% (non-condensing at ambient)

Maximum Altitude Operating: 10,000 ft (3048 m) Non-operating: 30,000 ft (9144 m) (unpressurized)

Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	SFF	MT	
Standard Efficiency	240W active PFC	320W active PFC	
High Efficiency*	240W active PFC 87/90/87% efficient @ 20/50/100% load	320W active PFC 87/90/87% efficient @ 20/50/100% load	
Operating Voltage Range	90 - 20	64 VAC	
Rated Voltage Range	100 - 2	40 VAC	
Rated Line Frequency	50/60 Hz		
Operating Line Frequency Range	47 - 63 Hz		
Rated Input Current	4A	5.5A	
Rated Input Current with Energy Efficient* Power	4A	5.5A	
Supply			
Current Leakage (NFPA 99)	< 275 μA	$<$ 450 μ A	
Power Supply Fan	92mm variable speed		
Power Cord Length	6.0 ft. (1.83 m)		

^{*} High efficiency power supply is a requirement for ENERGY STAR qualification in conjunction with a select range of processors and modules



Technical Specifications

ROM BIOS Information

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Compaq 6200 Pro Series
 PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Supports UEFI specification 2.1
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so
 component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any
 enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe recovery. In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS software and from the support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
 configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made
 to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
 management, allowing operating systems and applications to manage power based on activity and usage. HP Compaq
 business PCs use ACPI to provide power conservation features.
 - S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.

Other Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
 Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- System Management BIOS v2.6
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button



Technical Specifications

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - O Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
 - 2 processor thermal protection activated
 - 3 processor not installed
 - 4 power supply failure
 - 5 memory error
 - 6 video error
 - 7 PCA failure (ROM detected failure prior to video)
 - 8 invalid ROM, bootblock recovery mode
 - 9 system not fetching code
 - 10 system hang while loading an option ROM
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy identification

Additional Features	Description
Towardla Orientation	SEE can be oriented as either a dealton or a tower

Towerable Orientation SFF can be oriented as either a desktop or a tower

Implementation of the industry standard ATA Security feature set. When enabled, it Drive Lock

passwords are provided.

DPS Access through F10 Setup during Boot

A diagnostic hard drive self test. It scans critical physical components and every sector of

the hard drive for physical faults and then reports any faults to the user

Running independently of the operating system, it can be accessed through a Windowsbased diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be

replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures

SMART Technology (Self-Monitoring,

Drive Protection System

Allows hard drives to monitor their own health and to raise flags if imminent failures



Technical Specifications

Analysis and Reporting Technology)

SMART I - Drive Failure Prediction

SMART II - Off-Line Data Collection

SMART III - Off-Line Read Scanning with Defect Reallocation

SMART IV - End-to-End CRC for hard drives

were predicted

Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count

By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure

IOEDC: I/O Error Detection Circuitry

Detects errors in Read/Write buffers on HDD cache RAM

Interface in F10 setup provides confirmation of SMART IV support.



Technical Specifications - Audio

High Definition Audio

Type Integrated

HD Stereo Codec Realtek 2-channel ALC261 codec

Audio I/O Ports Front microphone-In (150-K ohm Input Impedance)

Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by audio

driver)

Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load)

Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load)

Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or Headphone output to support connecting two headphones to the front of the system. When configured as a second front headphone output, both front headphone outputs are always driven

with the same signal.

All ports are 3.5mm in diameter

Internal Speaker Amplifier For the internal speaker only. External speakers must be powered externally. Rear Line-in audio

port is re-taskable as either Line-in or Microphone-In.

Multi-streaming Capable Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to

be sent to/from the front and rear jacks.

Sampling 8 kHz - 192 kHz

Wavetable Syntheses

(software) Yes - Uses OS soft wavetable

Analog Audio Yes

of Channels on Line-Out

(mono/stereo)

Stereo (Left & Right channels)

Internal Audio Speaker Power

Rating

1.5 W

Internal Speaker Yes

External Speaker Jack

(Line-Out)

Yes



Technical Specifications - Audio

HP Thin USB Powered Speakers

On/Off/Volume Controls Right side of right speaker

Power LED Front of right speaker (green)

Frequency Response FO to 20kHz

Watts 2/3 watt (normal/maximum)

 Dimensions/Speaker
 $5.72 \times 3.74 \times 0.96$ in

 (H x W x D)
 $14.52 \times 9.50 \times 2.45$ cm

Net Weight 0.68 lbs

Color

0.31kg Black

Environmental Operating Temperature: 14° to 104° F

(all conditions non-condensing) -10° to 40° C

Relative Humidity 40% to 90%

Speaker Cable Length Input Cord: 5.91 ft

1800mm

 $\textbf{L-channel Cord:} \ \frac{3.28 \text{ ft}}{1000 \text{mm}}$

USB Cord: 5.91 ft 1800mm

SRS Premium Sound Technology

SRS Premium Sound™ is a state-of-the-art solution suite which optimizes the audio experience for all business applications including VoIP, computer based training, business presentations and digital content creation for any speaker configuration (notebook / desktop speakers or headphones). SRS Premium Sound delivers natural and immersive surround sound complete with deep, enveloping bass and crystal clear dialog which allows users to clearly hear audio and voice in communications or presentations and ensures that digital content can be experienced with uncompromised quality.

SRS Premium Sound Features

- Premium audio experience for all applications including VoIP, Video Conferencing, Webcasts, Multimedia Presentations and Digital Content Creation
- Natural and Immersive sound from two speakers or headphones
- Custom-tuned solutions to provide superior natural sound from desktop speakers and headphones
- Crystal clear dialog
- Deep, rich bass
- Intuitive user interface with presets for ease of use

SRS Premium Sound Benefits

- Turn your desktop into a multimedia powerhouse!
- Bring your business communication to life with natural sounding voice and clear dialog
- Increase productivity by making computer based training, webcasts and VoIP available anytime and anywhere with crystal clear audio
- Make presentations shine with rich, expansive sound without the need for external speakers

DA - 13880

• Take digital content creation to a new level with deep bass, enhanced fidelity and immersive surround sound which ensures that your content is heard with uncompromised quality and detail



Technical Specifications - Communications

Intel 82579LM GbE Network Connection (integrated)

Connector RJ-45

System Interface Integrated on PCA

Controller Intel 82579LM GbE platform LAN connect networking controller

Memory 24 KB FIFO packet buffer memory

Data rates supported 10/100/1000 Mbps

IEEE Compliance 802.1P

802.1Q 802.2 802.3 802.3ab 802.3az 802.3u

Bus architecture PCI Express and SMBus

Data transfer mode PCle-based interface for active state operation (S0 state) and SMBus for host and management

traffic (Sx low power state)

Power requirement Requires 3.3V and 1.05V or just 3.3V with integrated regulators

Power consumption 0.697 Watts

Boot ROM support Yes

Network transfer mode Full-duplex

Half-duplex (not supported for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps Operating Temperature: 0° to 85° C

Environmental Operating Temperature: 0° to 85° C

Operating Humidity: 60% RH

Management WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic.

Alerting ASF 2.0 support

Technical Specifications - Communications

Intel Gigabit CT Desktop Network Interface Controller

Connector RJ-45

System Interface PCI Express x1

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data rates supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802,1Q, 802.2, 802.3, 802.3AB and 802.3u compliant, 802.3x flow control

Bus architecture PCI-E 1.0a

Data path width X1, 250 MB/s, Bi-directional interface

Data transfer modeBus-master DMA

Hardware certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark for European Union

Power requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps

1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI Bus)

Environmental Operating Temperature: 32° to 131°F (0° to 55° C)

Operating Humidity: 85% at 131° F (55° C)

Dimensions 4.75 x 2.25 x 0.8 in (12.1 x 5.7 x 2.0 cm)

Management WOL, PXE, DMI, WFM 2.0

HP 802.11 b/g/n Wireless Network Connection

Dimensions (L x H) 2.8 x 2.2 in (7.0 x 5.7 cm)

Weight 0.08 lbs (40 g)

Controller Ralink RT2790

System interface PCI Express x1

Network standard 802.11 b/g/n

Frequency band 2.400 - 2.497 GHz

Operating temperature 14° to 149°F, operating (-10° to 65°C, operating)

Storage temperature -40° to 176°F, non-operating (-40° to 80°C, non-operating)

Humidity 10-90% operating

5-95% non-operating

Operating voltage 3.3V +/- 9%

12V +/- 8%



Technical Specifications - Communications

recrimed opecimedions	Commonications			
Power Consumption	Platform/WLAN Mode		Power Cor	nsumption
	Maximum Power Consumption:		10 Watts	
	Transmit Only		4 Watts maximum average second	ged power over 1
	Transmit Packet or Active Scanning		1000 mA peak current for longer	or 100 microseconds or
	Receive Only Mode or Idle without IEEE PSF mode enabled	0	3 Watts maximum average	ged over 1 second
	Idle, with IEEE PSP mode enabled	ode enabled 1.0 Watts maxim		raged over 1 second
	Transmit Disabled (turned off in software)		50 mW maximum, averaged over 1 second	
	Platform in S3 or S4 (power removed from Low Profile PCI Expre Card)	ss	5 mW maximum, averag	ged over 1 second
Output Power	802.11b mode		+19 dBm +/- 1.0 dB m	aximum
(approximate)	802.11g mode		+17 dBm +/- 1.0 dB maximum	
	EWC mode		+17 dBm +/- 1.0 dB m all transmit chains)	aximum (total power in
Receive Sensitivity	Mode	Date	a Rate	Sensitivity
	802.11b	1 /	Иbps	-94 dBm
	802.11b	11	Mbps	-85 dBm
	802.11g	6 N	Иbps	-91 dBm
	802.11g	18	Mbps	-85 dBm
	802.11g	48	Mbps	-75 dBm
	802.11g	54	Mbps	-72 dBm
	EWC (2.4 GHz)	6.5	Mbps	-87 dBm
	EWC (2.4 GHz)	54	Mbps	-82 dBm
	EWC (2.4 GHz)	81	Mbps	-78 dBm
	EWC (2.4 GHz)	162	Mbps	-74 dBm

EWC (2.4 GHz)

EWC (2.4 GHz)



270 Mbps

300 Mbps

-68 dBm

-64 dBm

Technical Specifications - Communications

Data Transfer Rate	Data Rate (MCS)	Minimum Throughput
	1 Mbps (802.11 b)	700 kbps
	2 Mbps (802.11 b)	1.4 Mbps
	5.5 Mbps (802.11 b)	3.5 Mbps
	11 Mbps (802.11 b)	5.9 Mbps
	12 Mbps (802.11 g)	6 Mbps
	18 Mbps (802.11 g)	9 Mbps
	24 Mbps (802.11 g)	12 Mbps
	36 Mbps (802.11 g)	18 Mbps
	48 Mbps (802.11 g)	21 Mbps
	54 Mbps (802.11 g)	22.5 Mbps
	6.5 Mbps (20 MHz EWC)	4.5 Mbps
	13 Mbps (20 MHz EWC)	9 Mbps
	19.5 Mbps (20 MHz EWC)	13.5 Mbps
	26 Mbps (20 MHz EWC)	18 Mbps
	39 Mbps (20 MHz EWC)	27 Mbps
	52 Mbps (20 MHz EWC)	36 Mbps
	58.5 Mbps (20 MHz EWC)	40 Mbps
	65 Mbps (20 MHz EWC)	45 Mbps
	78 Mbps (20 MHz EWC)	54 Mbps
	104 Mbps (20 MHz EWC)	72 Mbps
	117 Mbps (20 MHz EWC)	81 Mbps
	130 Mbps (20 MHz EWC)	91 Mbps
	13.5 Mbps (40 MHz EWC)	8 Mbps
	27 Mbps (40 MHz EWC)	16 Mbps
	40.5 Mbps (40 MHz EWC)	24 Mbps
	54 Mbps (40 MHz EWC)	32 Mbps
	81 Mbps (40 MHz EWC)	48 Mbps
	108 Mbps (40 MHz EWC)	64 Mbps
	121.5 Mbps (40 MHz EWC)	72 Mbps
	135 Mbps (40 MHz EWC)	81 Mbps
Socurity	IEEE and WiEi compliant 61 / 129 bit WED anarystica	

Security IEEE and WiFi compliant 64 / 128 bit WEP encryption

AES: CCM

802.1x authentication

WPA: 802.1x. WPA-PSK and TKIP

WPA2 certification IEEE 802.11i

Cisco Certified Extensions, all versions through V5

Antenna HP part number 497317-003

Certifications Wi-Fi certified

Certifications for use by country United States, Canada, Peru, Taiwan



Technical Specifications - Graphics

Intel HD Graphics (integrated)

3D/2D Controller Microsoft DirectX 10.1 based with support for Pixel Shader 4.1

VGA Controller Integrated

DisplayPort v1.1a; integrated, multimode capable; supports HDCP and audio over DisplayPort

Bus Type PCI Express™ x16
RAMDAC Integrated, 350 MHz

Graphics memory is shared with system memory. Graphics memory usage varies depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback) support for playback of protected

video content.

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

HW Video Decode Hardware Accelerated decode for MPEG2 encrypted video; support for PAVP

Maximum Color Depth 32 bits/pixel

Memory

Maximum Vertical Refresh Rate 85 Hz at up to 1920x1440, 75 Hz at 2048x1536. Varies with mode and configuration. See table

below.

Integrated dual independent monitor support facilitated via one VGA port and one DisplayPort v1.1a integrated on the back plane of the system board and presented as part of the rear I/O set of interfaces. Support for DVI, HDMI, dual link DVI or second VGA monitor provided by optional HP DisplayPort adapters (see complete listing of available optional adapters elsewhere in this

Multi-display Support

QuickSpec).

The system can support greater than two monitors with the addition of an optional discrete araphics card. Both integrated graphics and discrete araphics can be utilized simultaneously.

Graphics/Video API Support

DirectX 10.1 support in hardware OpenGL 3.0 support in hardware

Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refi	resh Rates (Hz)
	Analog	Digital
640x480	85	60
800x600	85	60
1024x768	85	60
1280x720	85	60
1280x1024	85	60
1440x900	75	60
1600x900	75	60
1600x1200	85	60
1680x1050	75	60
1920x1080	85	60-R
1920x1200	85	60-R
1920x1440	85	N/A

Technical Specifications - Graphics

2048x1536 75 N/A 2560x1600 N/A 60*

NOTE: other resolutions may be available but are not recommended as the may not have been tested and qualified by HP NOTE: 60-R denotes reduced blanking timings are used on single-link DVI connections and may be used with other digital connections

AMD FirePro 2270 Graphics Card

PCI Express x16 (generation 2.0)

Form Factor Low Profile, half length, 2.3" x 6.6"

Full height bracket utilized when configured to CMT or MT

Graphics Controller AMD FirePro 2270 GPU

Single DMS-59 connector

Output Connector Supports dual analog displays with included DMS-59 to dual VGA Y cable.

Supports dual digital displays with optional DMS-59 to dual DVI cable.

Core Clock 600MHz Memory Clock 600MHz

Memory Frame Buffer 512MB, DDR3, 64-bit wide

Supported Graphics APIs

DirectX 11 support in hardware
OpenGL 4.0 support in hardware

Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Re	fresh Rate (Hz)
	Analog	Digital
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A



^{*} Only supported when using a DisplayPort connection

Technical Specifications - Graphics

AMD Radeon HD 6350 Graphics Card

PCI Express x16 (generation 2.0)

Form Factor Low Profile, half length, 2.3" x 6.6"

Full height bracket utilized when configured to CMT or MT

Graphics Controller AMD HD 6350 GPU

Single DMS-59 connector

Output Connector Supports dual analog displays with included DMS-59 to dual VGA cable.

Supports dual DVI displays with optional DMS-59 to dual DVI cable.

Core Clock 650MHz Memory Clock 800MHz

Memory Frame Buffer 512MB, DDR3, 64-bit wide

HDCP supported on DVI output using optional DMS-59 to dual DVI cable.

Supported Graphics APIs DirectX 11 support in hardware.

OpenGL 4.0 support in hardware.

Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Re	fresh Rate (Hz)
	Analog	Digital
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A

Technical Specifications - Graphics

AMD Radeon HD 6450 Graphics Card

PCI Express x16 (Generation 2.0)

Form Factor Low Profile, half length, 2.3" x 6.6"

Full height bracket utilized when configured to CMT or MT

Graphics Controller AMD HD 6450 GPU

One (1) DisplayPort1.1 One (1) Dual Link DVI-I

Includes a DVI to VGA adapter. Other optional adapter kits are available to support DVI-D, and

Output Connector HDMI monitor inputs (see a complete listing of available optional adapters elsewhere in this

QuickSpec).

Supports audio with video through the DisplayPort 1.1 connector. DisplayPort v1.2 support will be provided in a future driver update.

Core Clock 625MHz Memory Clock 800MHz

Memory Frame Buffer 512MB, DDR3, 64-bit wide

Digital: 2560 x 1600

Display Maximum Resolution Analog: 2048 x 1536

(see chart below for more resolutions)

Supported Graphics APIs

HDCP supported on DisplayPort 1.1 and DVI output.

DirectX 11 support in hardware.

Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Re	fresh Rate (Hz)
	Analog	Digital
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	60*
2048 x 1536	75	60*
2560 x 1600	N/A	60*

^{*} Only supported when using a dual link DVI or DisplayPort monitor connection



Technical Specifications - Graphics

AMD Radeon HD 6570 Graphics Card

PCI Express x16 (generation 2.0)

Form Factor Low Profile, half length, 2.3" x 6.6"

Includes full height bracket when configured in CMT or MT chassis.

Graphics Controller AMD HD 6570 GPU

Two (2) DisplayPort 1.1 One (1) Dual Link DVI-I

Includes a DVI-I to VGA adapter. Other optional adapter kits are available to support DVI-D, and

HDMI monitor inputs (see complete listing of available optional adapters elsewhere in this

Output Connector

QuickSpec).

Supports audio with video through the DisplayPort 1.1 connector. Audio is also supported with an

optional DisplayPort to HDMI Adapter.

DisplayPort 1.2 support will be provided in a future driver update.

Core Clock 650MHz Memory Clock 900MHz

Memory Frame Buffer 1GB of DDR3,128-bit wide

HDCP supported on DisplayPort and DVI output.

Supported Graphics APIs DirectX 11 support in hardware.

OpenGL 4.0 support in hardware

Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Ref	resh Rate (Hz)
	Analog	Digital
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	60
2048 x 1536	75	60
2560 x 1600	N/A	60

Technical Specifications - Graphics

NVIDIA NVS 295 Graphics Card

Form Factor PCI Express x16 (generation 2.0)

Low Profile, half length, 2.3" x 6.6"

Full height bracket utilized when configured to CMT or MT

NVIDIA NVS 295 Graphics Board **Graphics Controller**

Output Connectors Two (2) DisplayPort

Includes two (2) DisplayPort to VGA Adapters

Memory Frame Buffer 256 MB DDR3 SDRAM

Display Output Drives DisplayPort enabled digital displays at resolutions up to 2560×1600 at 60 Hz with

reduced blanking

Drives DVI enabled digital displays at resolutions up to 1920×1200 at 60 Hz with reduced

blanking (through DisplayPort to DVI-D (single link) cable)

Supported Graphics APIs OpenGL 3.0 in hardware

DirectX 10.0 in hardware

NVIDIA NVS 300 PCle x1 512MB Graphics Card

PCI Express x1

Low Profile, half length, 2.3" x 6.6" Form Factor

Full height bracket utilized when configured to CMT or MT

Graphics Controller Nvidia GT218 GPU

Memory Frame Buffer 512MB DDR3, 64-bit wide

Single DMS-59 connector

Supports dual analog displays with included DMS-59 to dual VGA Y cable. **Output Connectors**

Support dual digital displays with an optional adapters (see complete listing of available optional

adapters elsewhere in this QuickSpec).

Core Clock 520MHz Memory Clock 790MHz

OpenGL 3.3 support in hardware Supported Graphics APIs

DirectX 10.0 support in hardware

Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Re	fresh Rate (Hz)
	Analog	Digital
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R



Technical Specifications - Graphics

1920 x 1440 85 N/A 2048 x 1536 75 N/A

NOTE: 60-R denotes reduced blanking timings are used on single link DVI connections and may be sued with other digital connections.

NVIDIA NVS 300 PCle x16 512MB Graphics Card

PCI Express x16 (generation 2.0)

Form Factor Low Profile, half length, 2.3" x 6.6"

Full height bracket utilized when configured to CMT or MT

Graphics Controller Nvidia GT218 GPU

Memory Frame Buffer 512MB DDR3, 64-bit wide

Single DMS-59 connector

Output Connectors Supports dual analog displays with included DMS-59 to dual VGA cable.

Supports dual DVI displays with an optional DMS59 to dual DVI cable.

Core Clock 520MHz Memory Clock 790MHz

Supported Graphics APIs

OpenGL 3.3 support in hardware

DirectX 10.0 support in hardware

Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Re	fresh Rate (Hz)
	Analog	Digital
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A

Technical Specifications - Graphics

NVIDIA GeForce 405 Graphics Card

Form Factor PCI Express x16 (Generation 2.0)

Low Profile, half length, 2.3" x 6.6"

Full height bracket utilized when configured to CMT or MT

Graphics Controller

Output Connectors

One (1) VGA analog
One (1) DV/L digital

One (1) DVI-I digital

Memory Frame Buffer 512MB DDR3, 64-bit wide

Maximum Resolution Analog: 1920 x 1440 x 32bpp @ 75Hz

Digital: 1600 x 1200 x 32bpp @ 60Hz



Technical Specifications – Hard Disk Data Storage

Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP Compaq 6200 Pro Series supports the latest SATA 6.0Gb/s specification.

HP Drive Lock

HP Serial ATA Hard Drives offer enhanced security via a new Drive Lock. When enabled, this ATA security feature set prevents software access to user data on the drive until one or two user-defined passwords are provided.

SMART IV Technology

Self Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

Native Command Queuing

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

NOTE: GB = 1 billion bytes. Actual available capacity is less.



Technical Specifications – Hard Disk Data Storage

HP 160-GB 7.2K SATA 3.0Gb/s 2.5" Hard Disk Drive

Capacity 160,041,885,696 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA 2.0 (3.0 Gb/s)

Buffer Size 16 MB

Logical Blocks 312,581,808

Seek Time (typical reads, includes controller overhead, including settling)

Single Track: 2.0 ms

Average: 12 ms

Full-Stroke: 22 ms

Height (nominal) 0.374 in/9.5 mm

Width (nominal)

Media diameter: 2.5 in/63.5 mm

Physical size: 2.75 in/70 mm

Operating Temperature 41° to 131° F (5° to 55° C)

HP 160-GB 10K SATA 3.0Gb/s 2.5" Hard Disk Drive

Capacity 160,041,885,696 bytes

Rotational Speed 10,000 rpm

Interface Serial ATA 2.0 (3.0 Gb/s)

Buffer Size 16 MB

Logical Blocks 312,581,808

Seek Time (typical reads, includes controller overhead, including settling)

Single Track: 2.0 ms

Average: 12 ms

Full-Stroke: 22 ms

Height (nominal) 0.6 in (1.53 cm)

Width (nominal) Media diameter: 2.5 in/63.5 mm

Physical size: 2.75 in/70 mm

Operating Temperature 41° to 131° F (5° to 55° C)

Technical Specifications – Hard Disk Data Storage

HP 250-GB 7.2K SATA 3.0Gb/s 2.5" Hard Disk Drive

250,059,350,016 bytes Capacity

Rotational Speed 7,200 rpm

Interface Serial ATA 2.0 (3.0 Gb/s)

Buffer Size 16 MB

Logical Blocks 488,397,168

Single Track: 2.0 ms Seek Time (typical reads, includes controller overhead, Average: 12 ms including settling)

Full-Stroke: 22 ms

0.374 in/9.5 mm Height (nominal)

Media diameter: 2.5 in/63.5 mm Width (nominal)

Physical size: 2.75 in/70 mm

41° to 131° F (5° to 55° C) Operating Temperature

HP 250-GB 7.2K SATA 6.0Gb/s 3.5" Hard Disk Drive

250,059,350,016 bytes Capacity

Rotational Speed 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

Buffer Size 16 MB

Logical Blocks 488,397,168

Single Track: 1.0 ms Seek Time (typical reads, includes controller overhead, Average: 8.5 ms including settling)

Full-Stroke: 18 ms

Height (nominal) 1 in/2.54 cm

Media diameter: 3.5 in/8.89 cm Width (nominal)

Physical size: 4 in/10.2 cm

41° to 131° F (5° to 55° C) Operating Temperature

Technical Specifications – Hard Disk Data Storage

HP 300-GB 10K rpm SATA 3.0Gb/s 2.5" Hard Disk Drive

300,069,052,416 bytes Capacity

Rotational Speed 10,000 rpm

Interface Serial ATA 2.0 (3.0 Gb/s)

Buffer Size 16 MB

Logical Blocks 586,072,368

Single Track: 0.7 ms Seek Time (typical reads, includes controller overhead, Average: 4.4 ms including settling)

Full-Stroke: 9.5 ms

Height (nominal) 0.6 in (1.53 cm)

Media diameter: 2.5 in (6.36 cm) Width (nominal) Physical size: 2.75 in (6.99 cm)

41° to 131° F (5° to 55° C) Operating Temperature

HP 320-GB 7.2K rpm SATA 3.0Gb/s 2.5" Hard Disk Drive

320,072,933,376 bytes Capacity

Rotational Speed 7,200 rpm

Interface Serial ATA 2.0 (3.0 Gb/s)

Buffer Size 16 MB

Logical Blocks 488,397,168

Single Track: 2.0 ms Seek Time (typical reads, includes controller overhead, Average: 12 ms including settling) Full-Stroke: 22 ms

0.374 in/9.5 mm Height (nominal)

Media diameter: 2.5 in/63.5 mm Width (nominal)

Physical size: 2.75 in/70 mm

41° to 131° F (5° to 55° C) Operating Temperature

Technical Specifications – Hard Disk Data Storage

HP 320-GB 7.2K rpm SATA 3.0Gb/s 2.5" Self-Encrypting Hard Disk Drive

Capacity 320,072,933,376 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA 2.0 (3.0 Gb/s)

Buffer Size 16 MB

Logical Blocks 488,397,168

Seek Time (typical reads, includes controller overhead, including settling)

Single Track: 2.0 ms

Average: 12 ms

Full-Stroke: 22 ms

Height (nominal) 0.374 in/9.5 mm

Width (nominal)

Media diameter: 2.5 in/63.5 mm

Physical size: 2.75 in/70 mm

Operating Temperature 41° to 131° F (5° to 55° C)

HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 500,107,862,016 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

Buffer Size 16 MB

Logical Blocks 976,773,168

Seek Time (typical reads, includes controller overhead, including settling)

Single Track: 2.0 ms

Average: 11 ms

Full-Stroke: 21 ms

Height (nominal) 1 in/2.54 cm

Width (nominal)

Media diameter: 3.5 in/8.89 cm

Physical size: 4 in/10.2 cm

Operating Temperature 41° to 131° F (5° to 55° C)

Technical Specifications – Hard Disk Data Storage

HP 750-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 750,107,862,016 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

Buffer Size 16 MB

Logical Blocks 976,773,168

Seek Time (typical reads, includes controller overhead, including settling)

Single Track: 2.0 ms

Average: 11 ms

Full-Stroke: 21 ms

Height (nominal) 1 in/2.54 cm

Width (nominal)

Media diameter: 3.5 in/8.89 cm

Physical size: 4 in/10.2 cm

Operating Temperature 41° to 131° F (5° to 55° C)

HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity 1,000,204,886,016 bytes

Rotational Speed 7,200 rpm

Interface Serial ATA 3.0 (6.0 Gb/s)

Buffer Size 32 MB

Logical Blocks 1,953,525,168

Seek Time (typical reads, includes controller overhead, including settling)

Single Track: 2.0 ms

Average: 11 ms

Full-Stroke: 21 ms

Height (nominal) 1 in/2.54 cm

Width (nominal)

Media diameter: 3.5 in/8.89 cm

Physical size: 4 in/10.2 cm

Operating Temperature 41° to 131° F (5° to 55° C)

Technical Specifications – Solid State Data Storage

HP 80-GB Solid State Drive

Unformatted Capacity 80-GB

Bandwidth Performance

Architecture Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller

Interface Serial ATA 2.0 (3.0 Gb/s)

2.74 x 0.37 x 4 in/6.98 x 0.95 x 10.2 cm Dimensions (W \times H \times D)

Weight 0.18 lb/80 g

Sustained Sequential Read: Up to 250 MB/s

Sustained Sequential Write: Up to 70 MB/s

Random Read: Up to 35K IOPs

Random Write: Up to 6.6K IOPs

Read: 65-ms Latency

Write: 85-ms

DC power requirement: 5 VDC 5%-100 mV ripple p-p Power

Total power consumption: 0.15W (active); 0.075W (idle)

Useful Drive Life 35TB written, up to 20GB/day for 5 years

Operating Temperature: 32° to 158° F (0° to 70° C)

Relative Humidity: 5% to 95%

Maximum Wet Bulb 84° F (29° C) Temperature (operating): (all conditions, non-condensing)

Shock: 1,500 G/0.5-ms

NOTE:

Environmental

For solid state disk drives, GB means 1 billion bytes. 16GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity varies by content and will be less than 15.8GB.

HP 120-GB Solid State Drive

Unformatted Capacity 120 GB

Architecture Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller

Serial ATA 2.0 (3.0 Gb/s) Interface

Dimensions (W \times H \times D) 2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)

Weight 0.18 lb (80 g)

Sustained Sequential Read: Up to 250 MB/s

Sustained Sequential Write: Up to 70 MB/s Bandwidth Performance

Random Read: Up to 35K IOPs Random Write: Up to 6.6K IOPs

Read: 65-ms

Write: 85-ms

DC power requirement: 5 VDC 5%-100 mV ripple p-p Power

Total power consumption: 0.15W (active); 0.075W (idle)

Useful Drive Life 35TB written, up to 20GB/day for 5 years



Latency

(all conditions, non-condensing)

Technical Specifications – Solid State Data Storage

Operating Temperature: 32° to 158° F (0° to 70° C)

Relative Humidity: 5% to 95%

Maximum Wet Bulb Temperature (operating): 84° F (29° C)

Shock: 1,500 G/0.5-ms

NOTE:

Environmental

For solid state disk drives, GB means 1 billion bytes. 16GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity varies by content and will be less than 15.8GB.

HP 160-GB Solid State Drive

Unformatted Capacity 160-GB

Architecture Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller

Interface Serial ATA 2.0 (3.0 Gb/s)

Dimensions (W \times H \times D) $2.74 \times 0.37 \times 4 \text{ in}/6.98 \times 0.95 \times 10.2 \text{ cm}$

Weight 0.18 lb/80 g

Bandwidth Performance

Sustained Sequential Read: Up to 250 MB/s

Sustained Sequential Write: Up to 70 MB/s

Random Read: Up to 35K IOPs

Random Write: Up to 6.6K IOPs

Read: 65-ms

Latency Write: 85-ms

DC power requirement: 5 VDC 5%-100 mV ripple p-p Power

Total power consumption: 0.15W (active); 0.075W (idle)

Useful Drive Life 35TB written, up to 20GB/day for 5 years

Operating Temperature: 32° to 158° F (0° to 70° C)

Relative Humidity: 5% to 95%

Environmental Maximum Wet Bulb 84° F (29° C) Temperature (operating): (all conditions, non-condensing)

Shock: 1,500 G/0.5-ms

NOTE:

For solid state disk drives, GB means 1 billion bytes. 16GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity varies by content and will be less than 15.8GB.



Technical Specifications - Input/Output Devices

HP USB Standard Keyboard

Physical characteristics Keys 104, 105, 106, 107, 109 layout (depending upon country)

Dimensions $18.0 \times 6.4 \times 0.98 \text{ in}$ $(L \times W \times H)$ $45.8 \times 16.3 \times 2.5 \text{ cm}$

40.0 X 10.0 X 2.0 C

2 lb 0.9 kg

Electrical Operating voltage $+ 5VDC \pm 5\%$

Weight

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Mechanical Languages 38 available

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Environmental Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock 40 g, six surfaces
Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Technical Specifications - Input/Output Devices

Approvals UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

Kit contents Keyboard Installation Guide

Warranty Card Safety and Comfort Guide

HP PS/2 Standard Keyboard

Physical Characteristics Keys 104, 105, 106, 107, 109 layout (depending upon country)

Dimensions 18.0 x 6.4 x 0.98 in (45.8 x 16.3 x 2.5 cm)

 $(L \times W \times H)$

Weight 2 lb (0.9 kg) minimum

Electrical Operating voltage + 5VDC ± 5 %

Power consumption 50-mA maximum (with three LEDs ON)

System interface PS/2 6-pin mini din connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft PC 99 - 2001 Functionally compliant

Mechanical Languages 38 available

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft

1.8 m

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Environmental Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces



Technical Specifications - Input/Output Devices

Operating vibration 2-g peak acceleration

Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Approvals UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

HP USB Smart Card (CCID) Keyboard

Introduction:

Boost your security, simplify access procedures and reduce the costs associated with managing networks by preventing unauthorized access to your computers and networks using smartcard technology with the HP Smart Card (CCID) Keyboard.

The USB Smart Card (CCID) Keyboard is a full-sized keyboard that takes advantage of digital signatures and certificates to secure the environment for transactions performed on both public and private networks. The USB Smart Card (CCID) Keyboard works with all smart cards that comply with ISO standard 7816.

Smart cards are easy-to-use credit card-sized devices which require multiple forms of information to be validated before you gain access to your accounts or resources. Used worldwide, smart cards strengthen access to a network or other resource using dual-factor authentication. Implementing a two-factor authentication (or multi-factor authentication) process reduces the risk of unauthorized access by verifying and validating your identity in one of the following ways:

- Something you know a combination of username and password or PIN
- Something you have a smart card or security token.

Something you have (smart card) plus something you know (PIN), improves user-access security within corporate network environments. Smart cards are used in government agencies, healthcare companies and the finance industry.

HP ProtectTools Smart Card Manager provides authentication software for the smart card. The Smart Card Reader module works with the HP ProtectTools Security Manager and enables the user to setup, use, and manage the smart card. This allows strengthened security with HP patented technology.

Key Benefits:

- Protects against unauthorized access with smart card technology
- Delivers even greater security when combined with a HP ProtectTools smart card and the HP ProtectTools Security Software
- Combination of username and password or pin with a smart card or security token
- Secures online transactions using digital signatures and certificates
- Conforms to industry standards for ease of setup and use
- Delivers long product life and quiet operation with high-impact materials and lubricated keys
- Spill drain feature

Keys

Physical Characteristics

104, 105, 106, 107, 109 layout

(depending upon country

Form factor USB basic smart card keyboard

Colors Carbonite/Silver



Technical Specifications - Input/Output Devices

 $\begin{array}{lll} \mbox{Dimensions} & 18.2 \times 6.3 \times 1.3 \ \mbox{in} \\ \mbox{(H x W x D)} & 46.3 \times 16.1 \times 3.3 \ \mbox{cm} \\ \mbox{Weight} & 2 \ \mbox{lb} \ \ (0.9 \ \mbox{kg}) \ \mbox{minimum} \\ \end{array}$

Electrical Operating voltage $+ 5VDC \pm 5\%$

Power consumption 100-mA maximum (with four LEDs ON)

System interface USB Type A plug connector ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft PC 99 - 2001 Functionally compliant

Mechanical Languages 30+ available

Keycaps Standard design

Switch actuation 55 g nominal peak force with tactile feedback

Switch life 20 million keystrokes

(using Hasco modified tester)

Switch type Contamination-resistant membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Environmental Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 20% to 80% (non-condensing at ambient)

Operating shock40 g, six surfacesNon-operating shock80 g, six surfacesOperating vibration2-g peak accelerationNon-operating vibration4-g peak acceleration

Drop 26 in (66 cm) on carpet, six-drop sequence (out of box)

Drop 42 in (107 cm) on concrete, 16-drop sequence

(in box)

SmartCard Function Support All ISO 7816 smart cards

Interface Reads from and writes to all ISO7816-1, 2, 3, 4 memory and

microprocessor smart cards (T=0, T=1)

Chipset SCM STCIII

Standard APIs supported PC/SC, EMV2000, CT-API

Power USB Port

Short circuit detection (protects smart card and reader)
Power supply compliant with ISO7816 and EMV (5V, 60 mA)

Supports 3-V and 5-V cards

Power consumption 100-mA maximum draw



Technical Specifications - Input/Output Devices

Communication From card 9600 bps to 330,000 bps

From computer 12 Mbps (USB transfer speed)

Landing mechanism Contact device Friction contact

Card insertions rating Up to 100,000 insertion cycles

Interface modes CCID protocol

Reader performance interface USB connection

Electro-magnetic standards Europe 2004/108/EC

USA USAFCC part 15

Approvals CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000, USB-IF

Ergonomic Compliance ISO 9241-4, TUVGS

Kit Contents Keyboard, I/O Security and Documentation CD, warranty card

Smart Card Compatibility HP HP ProtectTools Smart Card

American Express Amex Blue

Axalto (Schlumberger) Cryptoflex 8K

Cryptoflex 16K Cryptoflex 32K

Cryptoflex 32K e-gate Cyberflex Access 64K Cyberflex Access 32K Cyberflex 32K e-gate Cyberflex 64K Cyberflex Palmera

Payflex-S Payflex 1 K Payflex 2 K Payflex 4 K Payflex 8 K Prismera US DoD CAC

PrimeFlex Store 8K PrimeFlex Store 2K

Cardlogix CLXSU004KK4

CLXSU008KK5

Safenet, Inc. Model 300

Model 330

De-La Rue VisaCash
Gemplus Gem Expresso

Gerripius Gerri Expresso

GKK32K

Gemclub Memo GemClub Micro GemXplore GemSafe

Infineon SLE66C322P

SLE4406 SLE4406E SLE4406E SE SLE4418



Technical Specifications - Input/Output Devices

SLE4428 SLE4432

SLE4436E SLE4442

SLE5536

SafLink (Litronic) Forte

Shart Java Card

Oberthur CosmopolIIC v4

> CosmopolIIC v4.1 Cosmo ID-One GalatIIC v2.1 US DoD CAC

Memory Cards

Atmel AT24C01ASC

> AT24C02SC AT24C04SC AT24C08SC AT24C16SC AT24C32SC AT24C64SC AT24C128SC AT24C256SC AT24C512SC

AT88SC153 AT88SC1608

ISSI IS23SC4418

IS23SC4428

ST 14C02 Telefonkarte SLE4406

> SLE4436 SLE5536

XICOR X24026

HP USB & PS2 Washable Keyboard

Physical Characteristics Keys 104, 105, 106, 107, 109 layout (depending upon country)

> **Dimensions** 18.0 x 6.4 x 0.98 in $(L \times W \times H)$ 45.8 x 16.3 x 2.5 cm

> Weight 2 lb (0.9 kg) minimum

Electrical + 5VDC $\pm 5\%$ Operating voltage

> Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device



Technical Specifications - Input/Output Devices

Microsoft® PC 99 - 2001 Functionally compliant

Mechanical Keycaps Stepped -profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes

Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 7 ft

2.2 m

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Environmental Operating temperature 50° to 122° F

10° to 50° C

Non-operating temperature -4° to 149° F

-20° to 65° C

Operating humidity 10% to 95% (non-condensing at ambient)

Non-operating humidity 0% to 95% (non-condensing at ambient)

Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Approvals UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1,

IP66/NEMA4X

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

HP PS/2 Optical Mouse

Dimensions 1.56 x 2.44 x 4.61 in (H x L x W) 3.95 x 6.21 x 11.7 cm

Weight 4.44 oz

126 g

Environmental Operating temperature -32° to 104°F

 0° to 40° C



Technical Specifications - Input/Output Devices

Non-operating temperature -4° to 140°F

 -20° to 60° C

Operating humidity 10% to 90%

(non condensing at ambient)

Non-operating humidity 10% to 90%

(non condensing at ambient)

Operating shock 40 g, 6 surfaces

Non-operating shock 80 g, 6 surfaces

Operating vibration 2 g peak acceleration

Non-operating vibration 4 g peak acceleration

Drop 80 cm height onto asphalt tile over concrete or equivalent, 5-

(out of box) drop in 5 direction except the cable face

Electrical Operating voltage $5 \text{ VDC} \pm 10\%$

Power consumption 100mA

System consumption PS/2 mini-din connector

ESD CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft PC99 - 2001 Functionally compliant

Mechanical Resolution 400 \pm 20% DPI

Tracking speed 10 in/s (25.4 cm/s) maximum

Acceleration 100 in/s/s (2.54 m/s/s)

Switch actuation 61 g nominal peak force

Switch life 3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches

Tracking mechanism life 155 mi (250 km) at average speed of 10 in/s

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Scroll wheel Width 8 mm

Diameter 1.01 in (25.6 mm)

Maximum rotation speed 48 rats/sec

Switch type Light force micro-switch
Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions



Technical Specifications - Input/Output Devices

Regulatory Approvals UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

HP USB Optical Mouse

Dimensions 1.5 x 4.5 x 2.5 in (H x L x W) 3.8 x 11.6 x 6.3 cm

Weight 0.27 lb

0.12 kg

Cable length 72.8 in

185 cm

System requirements Microsoft Windows 95, 98, 2000, Me, XP and Vista

Available USB port

HP USB Laser Mouse

Scroll Wheel 24

Maximum Rotation Speed 48 rats/sec

Switch Type Wheel

Switch Life Button – 3,000,000

Wheel -1,000,000 times

Tilt switch - 500,000 times

Environmental Operating Temperature 32° to 104° F

 0° to 40° C

Non-operating Temperature -4° to 140° F

 -20° to 60° C

Operating Humidity 10% to 90%

(non-condensing at ambient)

Non-operating Humidity 20% to 80%

(non-condensing at ambient)

Operating Shock 40 g, six surfaces

Non-operating Shock 80 g, six surfaces

Operating Vibration 2-g peak acceleration

Non-operating Vibration 4-g peak acceleration

Electrical Operating Voltage + 5VDC ± 5 %

Power Consumption

MTBF > 150,000 hrs



Technical Specifications - Input/Output Devices

ESD IEC-61000-4-2 criteria B, Contact discharge: +/- 4kV, Air

discharge: +/- 8kV

EMI-RFI FCC Class B

PC98 PC 99 Compliant

Mechanical Resolution 800dpi

Tracking Speed 25 cm/sec

Acceleration 0.5mm

Switch Actuation 0.6N (60gf)

Switch Life Button - 3,000,000

Wheel - 1,000,000 times

Tilt switch - 500,000 times

Cable Length 1850mm

PC98-99 PC99 compliant

Regulatory Approvals UL60950-1, UL 94, UL 746 (A-E), UL 796

TUV/GS: EN 60950-1, EN 60825-1

FCC Class B, UL 1950, cUL, TUV GS, CE, C-tick, VCCI, BSMI, RRL



Technical Specifications - Removable Storage

HP Blu-ray Writer Drive

AMO Part Number AR482AA

Height 5.25-inch, half-height, tray-load

Orientation Either horizontal or vertical

Interface type SATA

Disc capacity 50 GB DL or 25 GB standard

Dimensions 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 19.0 cm)

 $(W \times H \times D)$

Disc Capacity

Weight 2.0 lb (907 g)

(max)

DVD-ROM 8.5GB DL or 4.7GB standard

Blu-ray 50GB DL or 25GB standard

Full Stroke DVD < 250 ms (seek)

Full Stroke CD < 210 ms (seek)

Blu-ray < 275 ms (seek)

(Time to drive ready from tray loading)

BD-ROM (SL/DL) 25S / 28S

BD-R (SL/DL) 25S / 28S

BD-RE (SL/DL) 25S / 28S

DVD-ROM (SL/DL) 18S / 18S

Startup Time DVD-R (SL/DL) 25S / 25S

DVD-RW 25S

DVD+R (SL/DL) 25S / 25S

DVD+RW DVD+RW 25S

DVD-RAM 45S

CD-ROM 15S

CD-ROM Read CD-ROM up to 40X

CD-R up to 40X

CD-RW up to 40X

DVD-ROM Read DVD-RAM up to 5X

DVD+RW up to 10X

DVD-RW up to 10X



Technical Specifications - Removable Storage

DVD+R DL up to 8X

DVD-R DL up to 8X

DVD-ROM up to 16X

Maximum Data Transfer Rates

DVD-ROM DL up to 8X

DVD+R up to 12X

DVD-R up to 12X

Blu-ray BD-ROM up to 6X

BD-ROM DL up to 4.8X

BD-R up to 6X

BD-R DL up to 4.8X

BD-R up to 6X

BD-RE SL/DL up to 4.8X

Power Source SATA DC power receptacle

DC Power Requirement 5 VDC \pm 5%-100 mV ripple p-p

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC -1000 mA typical, 1600 mA maximum

12 VDC -600 mA typical, 1400 mA maximum

Temperature (operating) 41° to 122° F (5° to 50° C)

Environmental (all conditions non-condensing)

Relative Humidity (operating)

(operating) 10% to 90%

Maximum Wet Bulb

Temperature (operating)

86° F (30° C)

HP SuperMulti DVD Writer Drive

AMO Part Number AR630AT

Height5.25-inch, half-height, tray-loadOrientationEither horizontal or vertical

Interface type Serial ATA

Dimensions (W x H x D) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Weight (max) 2.6 lb (1.2 kg)

CD Media Read Access Random < 120 ms typical

Full Stroke < 200 ms typical

DVD Media Read Access

Random < 130 ms typical

Full Stroke < 240 ms typical

CD-ROM, CD-R Read Up to 6000 KB/s (40X)

CD-RW Read Up to 4800 KB/s (32X)



Technical Specifications - Removable Storage

ı	O		
		Digital/Analog Audio Playback	Up to 2400 KB/s (16X)
	CD Media Read Transfer	Digital Audio Extraction (CD-ROM, CD-R)	Up to 6000 KB/s (40X)
		Digital Audio Extraction (CD-RW)	Up to 4800 KB/s (32X)
		Video CD Playback	Up to 2400 KB/s (16X)
		DVD-ROM SL Read	Up to 21600 KB/s (16X)
		DVD-ROM DL Read	Up to 10800 KB/s (8X)
		DVD Video Playback	Up to 10800 KB/s (8X)
		DVD Video SL (other than playback)	Up to 21600 KB/s (16X)
	DVD Media Read Transfer	DVD Video DL (other than playback)	Up to 10800 KB/s (8X)
		DVD-R	Up to 21600 KB/s (16X)
Performance		DVD+R	Up to 21600 KB/s (16X)
renormance		DVD-RW	Up to 10800 KB/s (8X)
		DVD-R DL	Up to 10800 KB/s (8X)
		DVD+RW	Up to 10800 KB/s (8X)
		CD-R Write	Up to 6000 KB/s (40X)
		CD-RW	600 KB/s (4X)
	CD Media Write Transfer	CD-RW (High speed)	1500 KB/s (10X)
		CD-RW (Ultra speed)	Up to 3600 KB/s (24X)
		CD-RW (Ultra speed+)	Up to 4800 KB/s (32X)
		DVD+R	Up to 21600 KB/s (16X)
		DVD+RDL(v1.2)	Up to 16200 KB/s (12X)
		DVD+RDL(v1.1)	Up to 10800 KB/s (8X)
		DVD+RW (Volume 2 v1.0)	Up to 10800 KB/s (8X)
		DVD+RW (Volume 1 v1.3)	Up to 5400 KB/s (4X)
		DVD-R (v2.1 rev. 6.0)	Up to 16200 KB/s (12X)
	DVD Media Write Transfer	DVD-R (v2.1 rev. 4.0)	Up to 21600 KB/s (16X)
		DVD-R DL (v3.0 rev. 5.0)	Up to 10800 KB/s (8X)
		DVD-R DL (v3.0 rev. 3.0)	Up to 10800 KB/s (8X)
		DVD-RW (v1.2 rev. 3.0)	8100 KB/s (6X)
		DVD-RW (v1.2 rev. 2.0)	Up to 5400 KB/s (4X)
		DVD-RAM (v2.2 rev. 5.0)	Up to 16200 KB/s (12X)
		DVD-RAM (v2.2 rev. 2.0)	Up to 6750 KB/s (5X)
	Media	Read	Write
	CD-ROM	Yes	No
	CD-R	Yes	No
	CD-RW	Yes	No
	DVD-ROM	Yes	No



Technical Specifications - Removable Storage

DVD-ROM DL Yes No Media Compatibility DVD-RAM Yes No

> DVD+RYes No DVD+R DL Yes No DVD+RWYes No DVD-R Yes No DVD-RW Yes No DVD-R DL Yes No

SATA DC power receptacle Source

 $5 VDC \pm 5\%$ 100 mV ripple p-p DC Power Requirement $12 VDC \pm 5\%$ 200 mV ripple p-p

<1000 mA (typical) 5 VDC 1600 mA (max.)

1200 mA (typical) DC Current 12 VDC 2000 mA (max.)

> Total Drive Power < 2.5W(Standby Mode)

SATA Power Connector, 15-pin Rear Panel SATA Data Connector, 7-pin

Markings to identify each connector

41° to 122° F Temperature (operating) (5° to 50° C) Temperature -22° F to 140° F (-30° C to 60° C) (storage)

Environmental conditions (all Relative Humidity 10% to 90% conditions non-condensing)

Maximum Wet Bulb 86° F (30° C)

Temperature 0 to 10,171 ft. Altitude

(0 to 3,100 meters)

HP DVD-ROM Drive

Power Supply

AMO Part Number AR629AA

Height 5.25-inch, half-height, tray-load Orientation Either horizontal or vertical

Interface type Serial ATA

Dimensions (W \times H \times D) 5.8 x 1.7 x 6.9 in (14.8 x 4.2 x 17.5 cm)

2.1 lb (950 kg) Weight (max)

> Random < 120 ms typical CD Media Read Access Full Stroke < 200 ms typical

Random < 130 ms typical **DVD Media Read Access** Full Stroke < 240 ms typical

> CD-ROM, CD-R Read Up to 6000 KB/s (40X)

Technical Specifications	- Removable Storage		
		CD-RW Read	Up to 4800 KB/s (32X)
		Digital/Analog Audio Playback	Up to 2400 KB/s (16X)
	CD Media Read Transfer	Digital Audio Extraction (CD-ROM, CD-R)	Up to 6000 KB/s (40X)
		Digital Audio Extraction (CD-RW)	Up to 4800 KB/s (32X)
Performance		Video CD Playback	Up to 2400 KB/s (16X)
		DVD-ROM SL Read	Up to 21600 KB/s (16X)
		DVD-ROM DL Read	Up to 10800 KB/s (8X)
		DVD Video Playback	Up to 10800 KB/s (8X)
		DVD Video SL (other than playback)	Up to 21600 KB/s (16X)
	DVD Media Read Transfer	DVD Video DL (other than playback)	Up to 10800 KB/s (8X)
		DVD-R	Up to 21600 KB/s (16X)
		DVD+R	Up to 21600 KB/s (16X)
		DVD-RW	Up to 10800 KB/s (8X)
		DVD-R DL	Up to 10800 KB/s (8X)
		DVD+RW	Up to 10800 KB/s (8X)
	Media	Read	Write
	CD-ROM	Yes	No
	CD-R	Yes	No
	CD-RW	Yes	No
	DVD-ROM	Yes	No
	DVD-ROM DL	Yes	No
Media Compatibility	DVD-RAM	Yes	No
	DVD+R	Yes	No
	DVD+R DL	Yes	No
	DVD+RW	Yes	No
	DVD-R	Yes	No
	DVD-RW	Yes	No
	DVD-R DL	Yes	No
	Source	SATA DC power receptacle	
	DC Power Requirement	$5 VDC \pm 5\%$	100 mV ripple p-p
	DC rower kequirement	$12 \text{ VDC} \pm 5\%$	200 mV ripple p-p
Power Supply		5 VDC	1000 mA (typical) 1600 mA (max.)
	DC Current	12 VDC	1200 mA (typical) 2000 mA (max.)
		Total Drive Power (Standby Mode)	< 2.5W



Environmental conditions (all

Rear Panel

conditions

non-condensing)

Technical Specifications - Removable Storage

SATA Power Connector, 15-pin SATA Data Connector, 7-pin

Markings to identify each connector

Temperature 41° to 122° F (operating) $(5^{\circ}$ to 50° C)

Temperature -22° F to 140° F (storage) $(-30^{\circ}$ C to 60° C)

Relative Humidity 10% to 90%

Maximum Wet Bulb Temperature 86° F (30° C)

Altitude 0 to 10,171 ft. (0 to 3,100 meters)

HP 22-n-1 Media Card Reader

USB 2.0 High-speed interface

USB Interface NOTE:

Requires the USB cable to be connected to the internal USB 2.0 port or a USB 2.0 PCI card.

Supports hardware ECC (Error Correction Code) function

Supports hardware CRC (Cyclic Redundancy Check) function

Supports MS 4-bit parallel transfer mode

Supports MS-PRO 4-bit parallel transfer mode

Advance protocol support

Supports MS PRO-HG Duo 4-bit parallel transfer mode

Supports SD 4-bit parallel transfer mode

Supports high-speed 50Mhz SD 4-bit card (version 2.0)
Supports high-speed 52Mhz MMC 8-bit card (version 4.2)

Supports CF v4.0 with PIO mode 6 and Ultra DMA mode

CompactFlash Type I
CompactFlash Type II

Microdrive

MultiMediaCard (MMC)

Reduced Size MultiMediaCard (RS MMC)

MultiMediaCard 4.2 (MMC Plus, including MMC Plus HC)

Reduced Size MultiMediaCard 4.2 (MMC Mobile, including MMC Mobile HC)

Secure Digital Card (SD)

Secure Digital High Capacity (SDHC)



Technical Specifications - Removable Storage

miniSD

Supported media type

miniSD High Capacity

Micro SD (T-Flash)

Micro SD HC

Memory Stick

Memory Stick Select

Memory Stick Duo (MS Duo)

Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo

MagicGate Memory Stick (MG)

MagicGate Memory Stick Duo

xD-Picture Card

Supported media type with card adapter

Memory Stick Micro (M2)

MMC Micro



Technical Specifications - Eco Data

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- US ENERGY STAR ®
- IT ECO declaration
- EPEAT Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country

Small Form Factor

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	30.9181 W	31.1382 W	30.9441 W
Sleep (Energy Star low power mode)	2.0709 W	2.2871 W	2.0928 W
Off	0.8967 W	1.0717 W	0.8803 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured model.

Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	106 BTU/hr	106 BTU/hr	106 BTU/hr
Sleep	7 BTU/hr	8 BTU/hr	7 BTU/hr
Off	3 BTU/hr	4 BTU/hr	3 BTU/hr

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions

(in accordance with ISO 7779 and ISO 9296)

System Fan Off	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Idle	3.8	28
Fixed Disk (random writes)	3.8	28

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight:

Battery Size

Battery type

Additional Information

CR2032 (coin cell)

Lithium

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe



Technical Specifications - Eco Data

- Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 4.10% post consumer recycled plastic (by wt.)
- This product is 93.8% recyclable when properly disposed of at end of life.

Packaging Materials

- External:
 - O Corrugated 1966 g
- Internal:
 - O Polyethylene low density Foam 154 g
- The corrugated packaging material contains at least 38.38% recycled content.
- The Polyethylene low density Foam packaging material contains at least 60.42% recycled content.

Microtower

Energy Consumption (typically	113
configured)	
Normal Operation	31.8
Sloop /Energy Star low	2.0

Normal Operation		
Sleep (Energy Star low		
power mode)		
Off		

115 VAC	230 VAC	100 VAC
31.8271 W	32.8944 W	31.7856 W
2.0348 W	2.2596 W	2.0193 W
0.8515 W	1.0293 W	0.8358 W

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured model.

Heat Dissipation (typically
configured)*
Normal Operation

Normal Operation	
Sleep	
Off	

115 VAC	230 VAC	100 VAC
109 BTU/hr	112 BTU/hr	109 BTU/hr
7 BTU/hr	8 BTU/hr	7 BTU/hr
3 BTU/hr	4 BTU/hr	3 BTU/hr

^{*} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Technical Specifications - Eco Data

Declared Noise Emissions

(in accordance with ISO 7779 and ISO 9296)

System Fan Off	Sound Power	Sound Pressure
	(LWAd, bels)	(LpAm, decibels)
ldle	3.9	28
Fixed Disk	3.9	28
(random writes)		

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight:

Battery Size Battery type

Additional Information

iery rype

CR2032 (coin cell)

Li-lor

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive – 2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0.13% post consumer recycled plastic (by wt.)
- This product is 92.4% recyclable when properly disposed of at end of life.

Packaging Materials

- External
 - O Corrugated Carton 1950 g
- Internal
 - O Polyethylene low density foam 205 g
- The corrugated packaging material contains at least 31.38% recycled content.
- The Polyethylene low density Foam packaging material contains at least 60.42% recycled content.

All Models

RoHS Compliance

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to



Technical Specifications - Eco Data

the HP General Specification for the Environment at:

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications



Packaging

Technical Specifications - Eco Data

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

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